

<b>Code</b>	<b>FCN</b>
<b>Company name</b>	Fecon Corporation
<b>Date</b>	10/26/2023
<b>Subject</b>	Plan for the 1 <sup>st</sup> bond private placement in 2023

**Content:**

On October 26, 2023, the BOD of Fecon Corporation approved the plan for the first bond private placement in 2023 as follow:

- Issuer: Fecon Corporation
- Bond code: FCNH2325001
- Bond type: non-convertible bond, secured and without warrant
- Par value: VND100,000,000/bond
- Issue volume: 1,500 bonds
- Issue value: VND150,000,000,000
- Issue date: October 31, 2023
- Term: 18 months
- Interest rate: 11%/year
- Issue price: 100% par value
- Interest payment term: once every 3 months